Multilayer Ceramic Chip Capacitors

1 of 3 Creation Date : April 03, 2017 (GMT)

C1005C0G1H560J050BA









TDK item description C1005C0G1H560JT****

Applications	Commercial Grade	
	Please refer to Part No. <u>CGA2B2C0G1H560J050BA</u> for Automotive use.	
Feature	General General (Up to 50V)	
Series	C1005 [EIA 0402]	
Status	Production (Not Recommended for New Design)	



	Size
Length(L)	1.00mm ±0.05mm
Width(W)	0.50mm ±0.05mm
Thickness(T)	0.50mm ±0.05mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.30mm to 0.50mm
Recommended Land Pattern (PB)	0.35mm to 0.45mm
Recommended Land Pattern (PC)	0.40mm to 0.60mm

Electrical Characteristics		
Capacitance	56pF ±5%	
Rated Voltage	50VDC	
Temperature Characteristic	C0G(0±30ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

Other		
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	10000pcs	

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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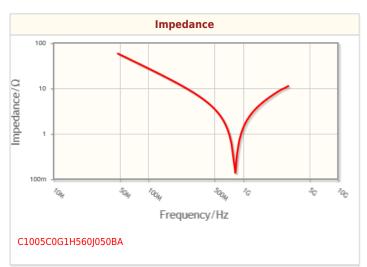


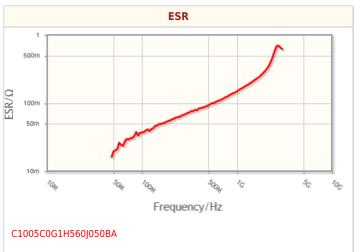


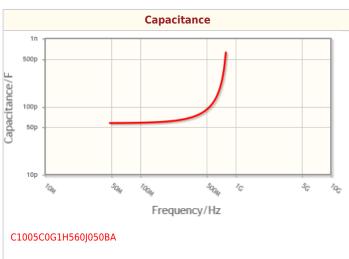


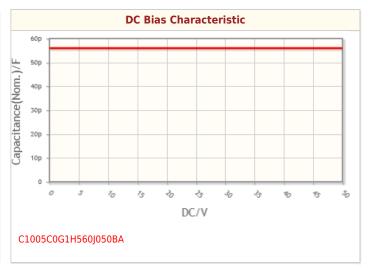


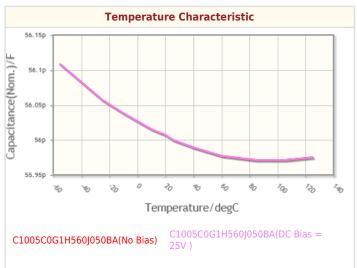
$Characteristic\ Graphs (This\ is\ reference\ data,\ and\ does\ not\ guarantee\ the\ products\ characteristics.)$











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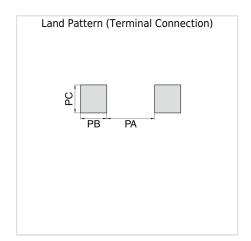






Associated Images

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